Silicon PNP Epitaxial

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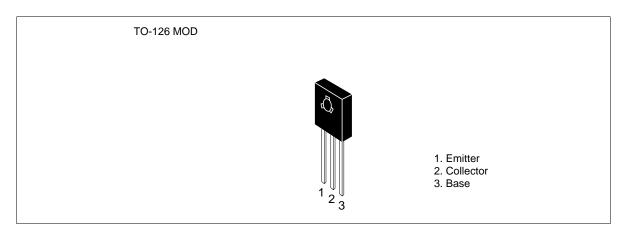
### Application

High frequency amplifier

### Features

- Excellent high frequency characteristics  $f_T = 300 \text{ MHz typ}$
- High voltage and low output capacitance
   V<sub>CEO</sub> = -200 V, Cob = 5.0 pF typ
- Suitable for wide band video amplifier

## Outline





## **Absolute Maximum Ratings** (Ta = 25°C)

Item	Symbol	Ratings	Unit	
Collector to base voltage	V <sub>CBO</sub>	-200	V	
Collector to emitter voltage	V <sub>CEO</sub>	-200	V	
Emitter to base voltage	V <sub>EBO</sub>	-5	V	
Collector current	Ι <sub>c</sub>	-0.2	А	
Collector peak current	I <sub>C(peak)</sub>	-0.5	А	
Collector power dissipation	Pc	1.25	W	
	Pc*1	10		
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Note: 1. Value at  $T_c = 25^{\circ}C$ .

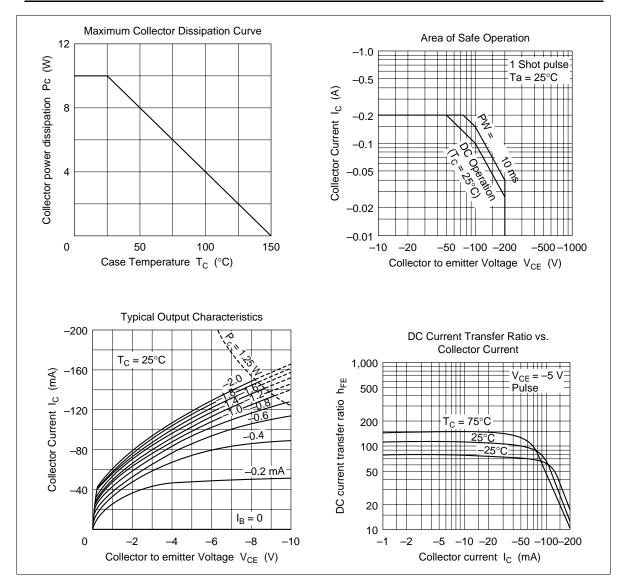
## **Electrical Characteristics** (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	-200	_	_	V	$I_{c} = -10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	-200	_	_	V	$I_c = -1 \text{ mA}, \text{ R}_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-5	_	_	V	$I_{\rm E} = -10 \ \mu A, \ I_{\rm C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_		-10	μΑ	$V_{CB} = -160 \text{ V}, I_{E} = 0$
DC current transfer ratio	$h_{FE}^{*1}$	60	—	200		$V_{ce} = -5 \text{ V}, \text{ I}_{c} = -10 \text{ mA}$
Base to emitter voltage	$V_{BE}$	_	—	-1.0	V	$V_{ce} = -5 \text{ V}, \text{ I}_c = -30 \text{ mA}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	—	_	-1.0	V	$I_{c} = -30 \text{ mA}, I_{B} = -3 \text{ mA}$
Gain bandwidth product	f <sub>⊤</sub>	200	300	_	MHz	$V_{ce} = -20 \text{ V}, I_c = -30 \text{ mA}$
Collector output capacitance	Cob		5.0		pF	$V_{_{CB}} = -30 \text{ V}, \text{ I}_{_{E}} = 0, \text{ f} = 1 \text{ MHz}$

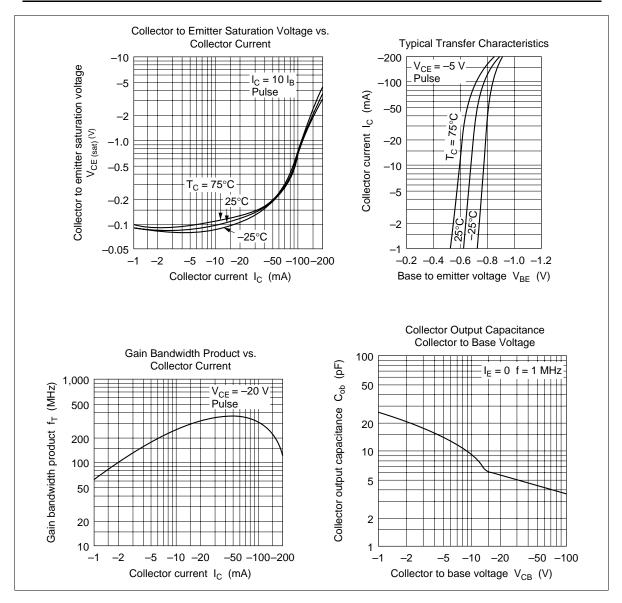
Note: 1. The 2SA1810 is grouped by  $h_{FE}$  as follows.

## B C 60 to 120 100 to 200

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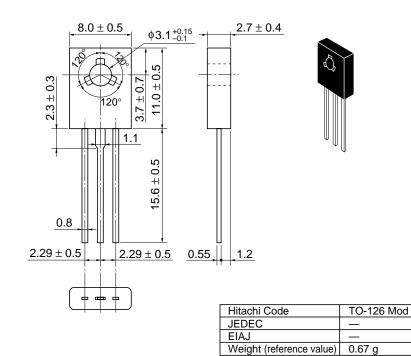


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#### Unit: mm



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